

MSKSEMI

SEMICONDUCTOR



ESD



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TSS



MOV

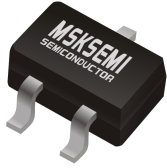


GDT

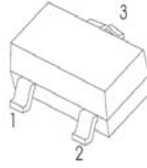


PLED

Product data sheet



SOT - 23



- 1. BASE
- 2. EMITTER
- 3. COLLECTOR

FEATURES

Ideally suited for automatic insertion
For switching and AF amplifier applications

DEVICE MARKING

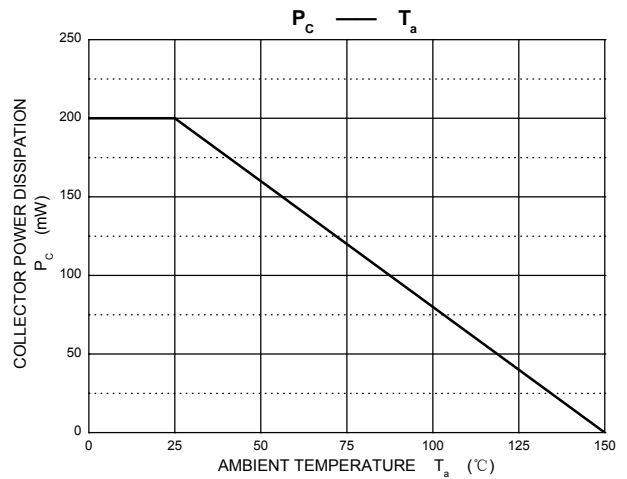
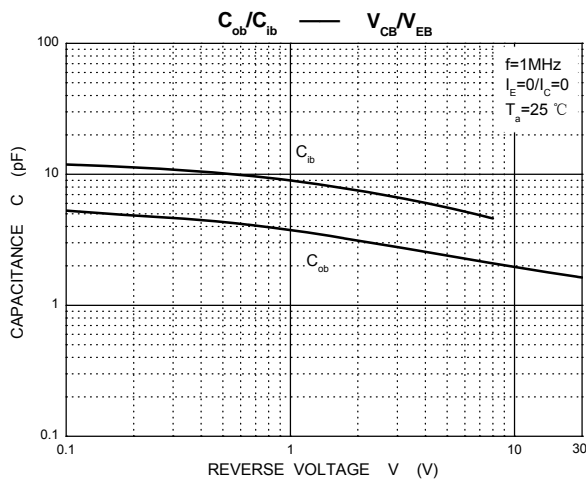
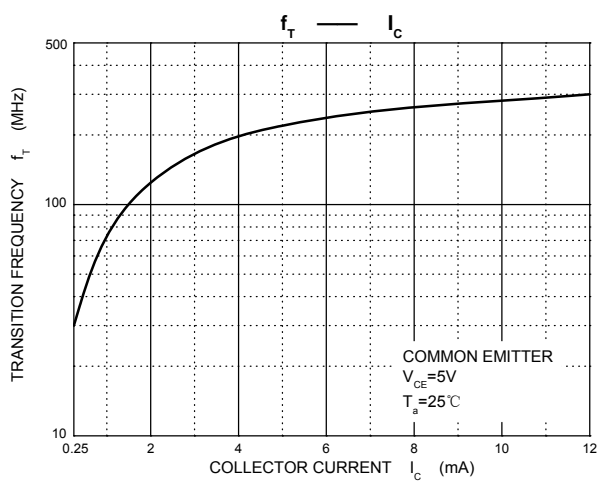
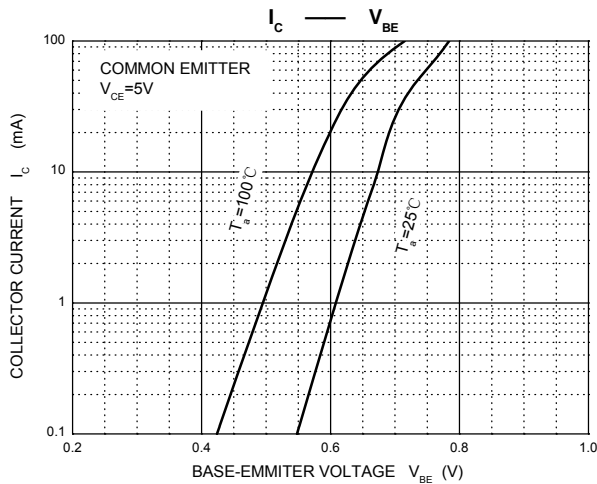
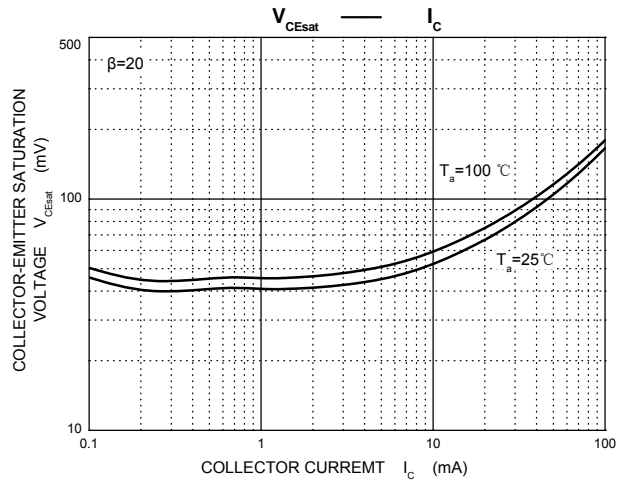
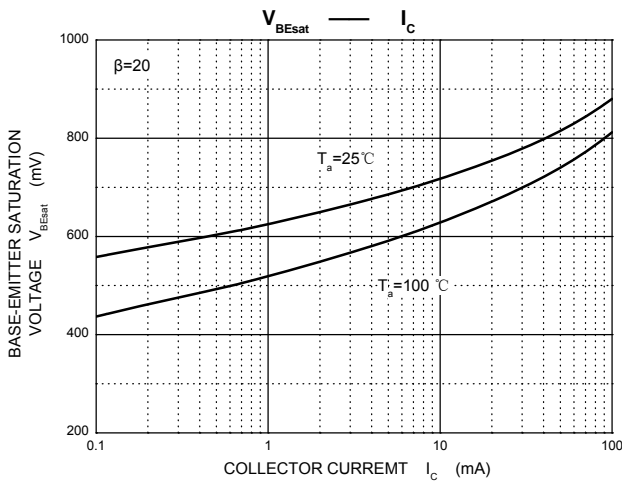
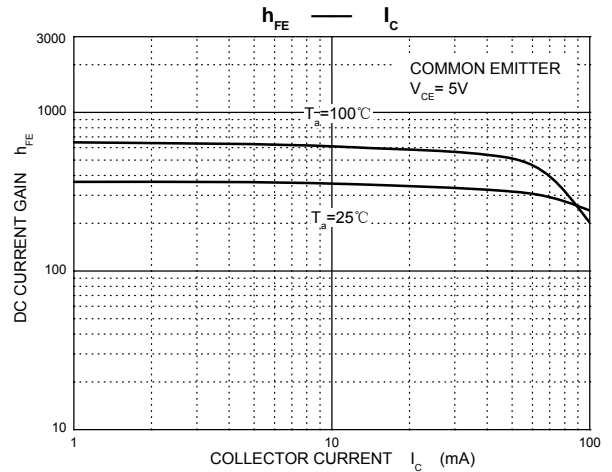
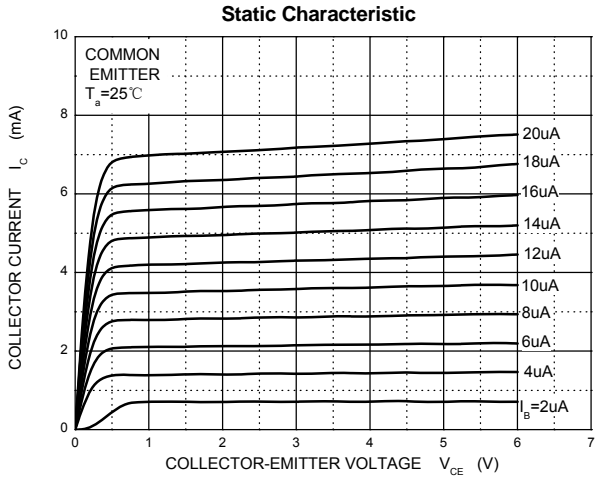
P/N	MARK	P/N	MARK	P/N	MARK
BC846A	1A	BC847A	1E	BC848A	1J
BC846B	1B	BC847B	1F	BC848B	1K
BC846C	1C	BC847C	1G	BC848C	1L

MAXIMUM RATINGS (T_a=25°C unless otherwise noted)

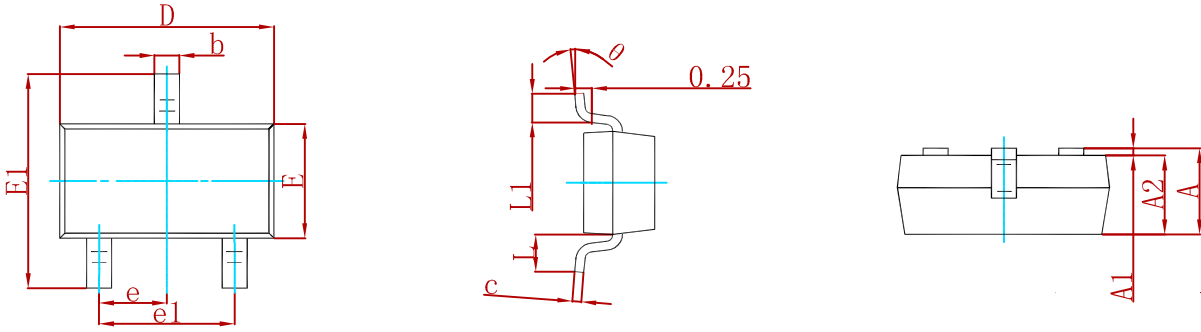
Symbol	Parameter	Value	Unit
V _{CBO}	Collector-Base Voltage	BC846	80
		BC847	50
		BC848	30
V _{CEO}	Collector-Emitter Voltage	BC846	65
		BC847	45
		BC848	30
V _{EBO}	Emitter-Base Voltage	6	V
I _C	Collector Current –Continuous	0.1	A
P _C	Collector Power Dissipation	200	mW
R _{θJA}	Thermal Resistance From Junction To Ambient	625	°C/W
T _J	Junction Temperature	150	°C
T _{stg}	Storage Temperature	-55~+150	°C

ELECTRICAL CHARACTERISTICS (T_a=25°C unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit	
Collector-base breakdown voltage	BC846	$I_C = 10\mu A, I_E = 0$	80			V	
	BC847		50				
	BC848		30				
Collector-emitter breakdown voltage	BC846	$I_C = 10mA, I_B = 0$	65			V	
	BC847		45				
	BC848		30				
Emitter-base breakdown voltage	V_{EBO}	$I_E = 10\mu A, I_C = 0$	6			V	
Collector cut-off current	BC846	I_{CBO}	$V_{CB} = 70V, I_E = 0$			0.1	μA
	BC847		$V_{CB} = 50V, I_E = 0$				
	BC848		$V_{CB} = 30V, I_E = 0$				
Collector cut-off current	BC846	I_{CEO}	$V_{CE} = 60V, I_B = 0$			0.1	μA
	BC847		$V_{CE} = 45V, I_B = 0$				
	BC848		$V_{CE} = 30V, I_B = 0$				
Emitter cut-off current	I_{EBO}	$V_{EB} = 5V, I_C = 0$			0.1	μA	
DC current gain	BC846A,847A,848A	h_{FE}	$V_{CE} = 5V, I_C = 2mA$	110		220	
	BC846B,847B,848B			200		450	
	BC846C,BC847C,BC848C			420		800	
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = 100mA, I_B = 5mA$			0.5	V	
Base-emitter saturation voltage	$V_{BE(sat)}$	$I_C = 100mA, I_B = 5mA$			1.1	V	
Transition frequency	f_T	$V_{CE} = 5V, I_C = 10mA$ $f = 100MHz$	100			MHz	
Collector output capacitance	C_{ob}	$V_{CB} = 10V, f = 1MHz$			4.5	pF	

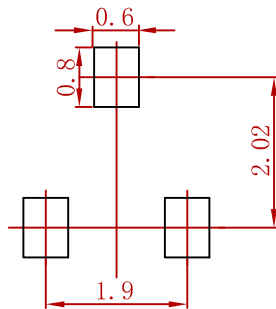


PACKAGE MECHANICAL DATA



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

Suggested Pad Layout



- Note:
1. Controlling dimension: in millimeters.
 2. General tolerance: ± 0.05mm.
 3. The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N	PKG	QTY
BC846/BC847/BC848	SOT-23	3000

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